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i.MX23 Applications Processor Data Sheet

Characteristics and specifications for the i.MX23 Applications Processor are located in Chapter 2, "Characteristics and Specifications," of the *i.MX23 Applications Processor Reference Manual* (order No. IMX23RM), available at http://www.freescale.com/files/dsp/doc/ref_manual/IMX23RM.pdf



This document contains information on a new product. Specifications and information herein are subject to change without notice.





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